Docket No. BS00-008

Declaration and Power of Atterney For Patent Application

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

-	lural names are list n the invention enti		, , ,
the specification of which			
(check one)			
☐ is attached hereto.			
■ was filed on December		as United States Application No	or PCT International
Application Number 09	0/746,648		
and was amended on		(if applicable)	
I hereby state that I have r	eviewed and unde	rstand the contents of the above i	dentified specification
including the claims, as am			dentined specification,
		ited States Patent and Trademarl as defined in Title 37, Code of	
Section 365(b) of any fore any PCT International appl listed below and have also	eign application(s) lication which desig identified below, b T International app	er Title 35, United States Code, for patent or inventor's certificate mated at least one country other to checking the box, any foreign a lication having a filing date before	han the United States, pplication for patent or
Prior Foreign Application(s)	•	Priority Not Claimed
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(Number)	(Country)	(Day/Month/Year Filed)	J
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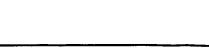




I hereby claim the benefit under application(s) listed below:	35 U.S.C. Section 119(e	e) of any United States provisional
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
insofar as the subject matter of ear United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to me	ach of the claims of this apparent application in the manner per the duty to disclose to the er to be material to patentable between the filing date of	the United States, listed below and, plication is not disclosed in the prior provided by the first paragraph of 35 United States Patent and Trademark polity as defined in Title 37, C. F. R., the prior application and the national (Status)
(Аррисацоп Senai No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(patented, pending, abandoned)



POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

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